Docket No. 520.43596X00 Serial No. 10/791,823 Office Action dated August 4, 2006

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

- 1. (Currently Amended) A liquid cooling system for use in an electronic apparatus including a heat-generating element therein, comprising:
 - a pump for supplying a cooling liquid;
- a heat-receiving jacket, being supplied with said cooling liquid, for receiving heat from the heat-generating element;
- a radiator, being supplied with said cooling liquid passing through said heatreceiving jacket, for radiating heat therefrom;

flow passages for circulating said cooling liquid in a route passing through said radiator back to said pump, said flow passages including parts that generate corrosive ions therefrom; and

a tank for accumulating said cooling liquid circulating within said flow passages, wherein:

the cooling liquid contained within said system is less than or equal to one liter in volume.

an ion exchange bag, having water-permeable surfaces, encloses an ion exchange resin therein, and is freely-disposed in the cooling liquid accumulated within said tank, and

said ion exchange bag enables ion exchange through diffusion on almost all water-permeable surfaces thereof.

2. (Previously Presented) The liquid cooling system, as described in the claim 1, wherein:

the ion exchange bag, having the water-permeable bag enclosing the ion exchange resin therein, is held within a container.

3. (Previously Presented) The liquid cooling system, as described in the claim 1, wherein:

said ion exchange bag is disposed within an inside or a downstream of said radiator, and also in one of parts building up the liquid cooling system in an upstream of said heat-receiving jacket.

4. (Previously Presented) The liquid cooling system, as described in the claim 2, wherein:

said ion exchange bag is disposed within an inside or a downstream of said radiator, and also in one of parts building up the liquid cooling system in an upstream of said heat-receiving jacket.

- 5. (Currently Amended) An electronic apparatus, comprising:
 - a heat-generation element mounted on a substrate;
- a heat-receiving jacket, being thermally connected to said heat-generation element;
- a heat radiation jacket for radiating heat of a heated liquid supplied from said heat-receiving jacket;
 - a pump for circulating the liquid to those jackets; and
 - a piping for connecting said pump and said both jackets, wherein:

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the cooling liquid contained within said system is less than or equal to one liter in volume.

an ion exchange bag, having a water-permeable bag enclosing ion exchange resin therein, is freely-disposed in said piping, and said ion exchange bag enables ion exchange through diffusion on water-permeable surfaces thereof.

- 6. (Previously Presented) The liquid cooling system of claim 1, wherein said ion exchange bag is in the form of an exchange holder.
- 7. (Previously Presented) The liquid cooling system of claim 6, wherein said ion exchange holder is held within a container.
- 8. (Previously Presented) The liquid cooling system of claim 6, wherein said ion exchange holder is disposed within an inside or a downstream of said radiator, and also in one of parts building up the liquid cooling system in an upstream of said heat-receiving jacket.